

5MHz-8000MHz

BSW7321

Product Description

The BSW7321 is a reflective SPDT RF switch that can be used in high power and good performance WLAN 802.11 a/b/g/n/ac/ax, DOCSIS 3.0/3.1 and Wireless Communication applications.

This device is packaged in RoHS2-compliant with 1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN package. It must be used with back side ground soldering.

The BSW7321 has robust ESD protection circuits at all pins and temperature performance (operating temperature range : -40 to +105°C).

This switch does not require blocking capacitors. If DC is presented at the RF port, add a blocking capacitor. This device also has a high linearity performance over all temperature range such as IIP3, IIP2.

A functional block diagram is shown in Figure 1.

Block Diagram

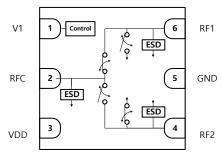


Figure 1 Functional Block Diagram

Applications

- WiMAX 802.16
- WLAN 802.11 a/b/g/n/ac/ax
- DOCSIS 3.0/3.1
- Drone
- Bluetooth
- Wireless Infrastructure
- Remote keyless entry
- Telematics / Infotainment
- Two-way radios
- Wireless control systems
- GPS/Navigation

Package Type



1.5mm x 1.5mm x 0.5mm, 6-Lead UDFN Package Figure 2 Package Type

Device Features

- Output frequency range : 5 MHz to 8.0 GHz
- Fast Switching Time : 105 to 145 ns
- Supply Voltage : 2.7V to 3.6V
- Low insertion loss
- : 0.58dB @ 2.45GHz : 0.86dB @ 5.75GHz
- High isolation
- : 43dB @ 2.45GHz
 - : 30dB @ 5.75GHz
- Input 1 dB output compression
 - : 39dBm @ 2.45GHz
 - : 39dBm @ 5.75GHz
- High IIP3
 - : 65dBm @ 2.45GHz
 - : 65dBm @ 5.75GHz
- ESD protection (HBM) : 2.0kV @ all pins
- 6-Lead UDFN package : 1.5mm x 1.5mm x 0.5mm
- Operating temperature range : -40°C to +105°C
- Lead-free/RoHS2-compliant UDFN package



Electrical Specifications

Typical conditions are at VDD = 3.3V, $T_A = 25^{\circ}$ C, V1 Low = 0V, V1 High = 3.3V, $Z_L = 50\Omega$, Excluding SMA Connector and PCB loss⁽¹⁾, unless otherwise noted.

Table 1 Electrical Specifications

Parameter	Path	Condition	Min	Тур	Max	Unit
Operating Frequency			5		8000	MHz
		1GHz		0.50		
		2GHz		0.57		
		3GHz		0.61		
Insertion Loss	RFC - RFx	4GHz		0.59		dB
		5GHz		0.65		üb
		6GHz		0.97		
		7GHz		0.88		
		8GHz		0.96		
		1GHz		52		
		2GHz		46		
		3GHz		30		
Isolation	RFC - RFx	4GHz		35		dB
130101011		5GHz		32		ub.
		6GHz		30		
		7GHz		29		
		8GHz		26		
	RFx - RFx	1GHz		44		
		2GHz		36		
to delta a		3GHz		33		
		4GHz		30		dB
Isolation	KFX - KFX	5GHz		29		ив
		6GHz		26		
		7GHz		25		
		8GHz		23		
Return Loss	RFC, RF1, RF2	5MHz – 8GHz (Active port)		15		dB
		2.45GHz		39		
Input P1dB	RFC - RFx	5.75GHz		39		dBm
(2)		2.45GHz		65		
Input IP3 ⁽²⁾	RFC - RFx	5.75GHz		65		dBm
(2)		2.45GHz		100		
Input IP2 ⁽²⁾	RFC - RFx	5.75GHz		100		dBm
		2.45GHz		90		
2 nd Harmonic ⁽³⁾	RFC - RFx	5.75GHz		90		dBc
rd (2)		2.45GHz		105		1
3 rd Harmonic ⁽³⁾	RFC - RFx	5.75GHz		105		dBc
		50% control to 90% RF		145		
Switching Time	RFC - RFx	50% control to 50% M		105		ns
	1	50% CTRL to 0.05dB final value Rising Edge		155		
Settling Time	RFC - RFx	50% CTRL to 0.05dB final value Rising Edge		155		ns

The typical spurious performance of the BSW7321 is -115dBm / 10Hz @ Over 10MHz

(1) Excluding SMA Connector and PCB loss.

1GHz (0.14dB), 2GHz (0.22dB), 3GHz (0.27dB), 4GHz (0.36dB), 5GHz (0.41dB), 6GHz (0.45dB), 7GHz (0.59dB), 8GHz (0.64dB)

(2) The two-tone Power is 18dBm each and Tone spacing is 20KHz.

(3) Tone Power is 18dBm.

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Product Description

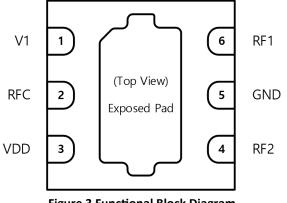


Figure 3 Functional Block Diagram

Table 3 V1 Control Truth Table

Table 2 Pin Descriptions

No.	Pin Name Descriptions	
1	V1	Digital Control Logic Input
2	RFC	RF Common port
3	3 VDD Supply Voltage	
4	RF2	RF2 port
5	GND	Ground
6	RF1	RF1 port
Pad	Exposed Pad	Ground

V1	RFC-RF1	RFC-RF2
0	OFF	ON
1	ON	OFF

Table 4 Recommended Operating Conditions*

Parameter	Symbol	Min	Тур	Max	Unit
Supply Voltage	VDD	2.7	3.3	3.6	V
Supply Current	IDD	-	170	-	μΑ
Digital Input Control (V1)	V1 High	1.0	-	3.3	V
	V1 Low	0	-	0.7	V
Operating Temperature Range	То	-40	+25	+105	°C
RF Input Power, CW Freq.=2.45GHz, 5.75GHz Any port, Ζι=50Ω	-	-	-	30	dBm

*Specifications are not guaranteed over all recommended operating conditions.

Table 5 Absolute Maximum Ratings

	Parameter		Symbol	Min	Max	Unit
	Supply Voltage		VDD	-0.3	3.6	V
Digital Input Voltage (V1)		V1	-0.3	3.6	v	
Maximur	Maximum Input Power, CW (+25°C)		-	-	Input P1dB	dBm
Stora	Storage Temperature range		-	-65	+150	°C
560	HBM	All pins	-	-	2000	V
ESD	CDM	All pins	-	-	1000	V

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5MHz-8000MHz

BSW7321

Typical Performances

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Figure 4 Insertion Loss vs. Vdd (RFC - RFx)

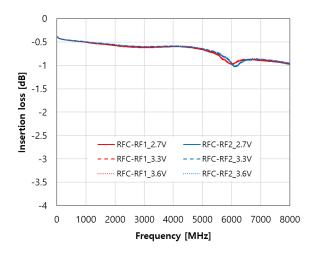


Figure 5 Insertion Loss vs. Temp (RFC - RFx)

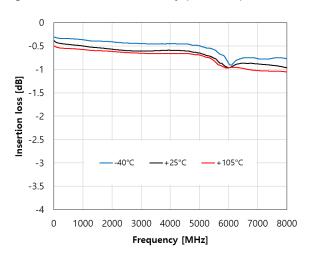


Figure 6 Return Loss (RFC, RFx)

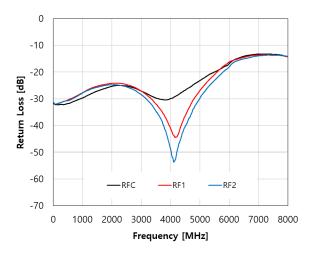
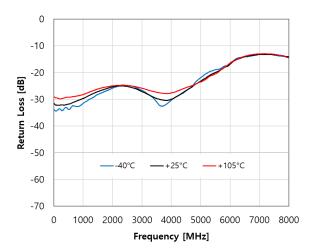


Figure 7 Return Loss vs. Temp (RFC)





5MHz-8000MHz

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Typical Performances

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Figure 8 Isolation vs. Vdd (RFC - RFx)

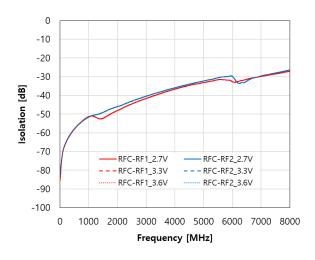


Figure 9 Isolation vs. Temp (RFC-RFx)

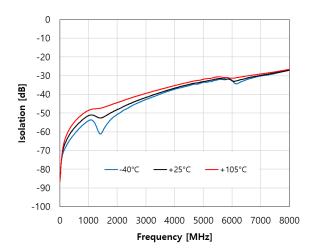


Figure 10 Isolation vs. Vdd (RFx - RFx)

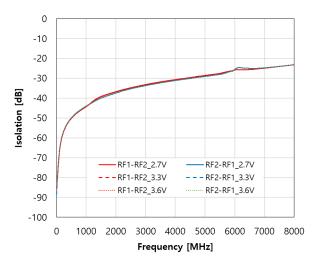
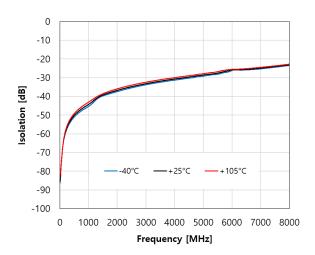


Figure 11 Isolation vs. Temp (RFx - RFx)





5MHz-8000MHz

BSW7321

Evaluation Board

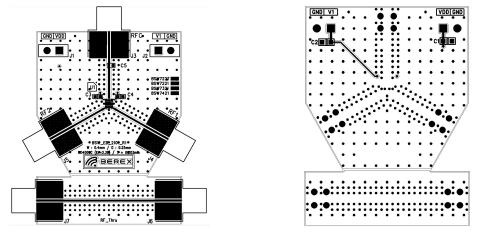
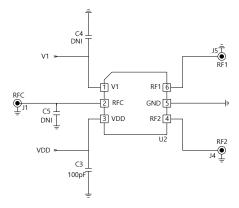


Figure 12 Evaluation Board Layout



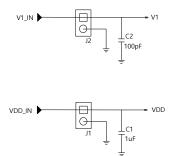


Figure 13 Evaluation Board Schematic

]
RO4003C Er : 3.38	
FR-4 Er : 4.5~4.8	
FR-4 Er : 4.5~4.8	
	1

COPPER : 1oz (0.035mm), Top La	<u>yer</u>
RO4003C / 0.2mm	
COPPER : 1oz (0.035mm), Inner 1	Layer
FR-4 / 0.36mm	FINISH THICKNESS : 1.63T
COPPER : 1oz (0.035mm), Inner 2	Layer
FR-4 / 0.93mm	
COPPER : 1oz (0.035mm), Bottom	Layer

No.	Ref Des	Part Qty	Part Number	Remark
1	C1	1	1 CAP 1005 1uF J 50V	
2	C2,C3*	2	CAP 1005 100pF J 50V	
3	C4	2	CAP 1005 DNI	
4	C5	1	CAP 0603 DNI	
6	J1,J2	2	2 Pin Header	
7	RFC, RF1, RF2	3	SMA_END_LAUNCH	
8	U1	1	BSW7321	

Figure 14 Evaluation Board PCB Layer Information

* C3 should be placed near the device.

Table 6 Bill of Material - Evaluation Board

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6

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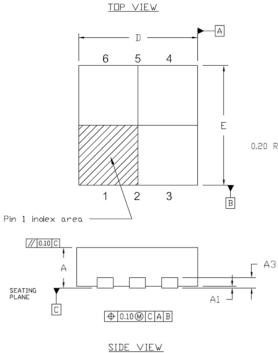


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BSW7321

Package Outline Drawing

NOTES :

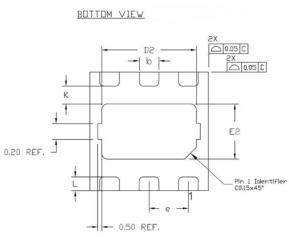


Dimension and tolerancing conform to ASME Y14.5M-1994.
Controlling Dimensions : Millimeter. Converted INCH dimension

3. Dimension b applied to Metallized terminal and is measured

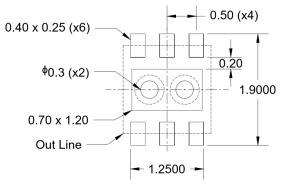
between 0.15 to 0.30mm from terminal tip.

are not necessarily exact.



N≻∑m□」	Common					
B	DIMENSI	ONS MILLI	METER	DIME	ENSIONS IN	КН
=	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
Α	0.45	0.50	0.55	0.018	0.020	0.022
A3	0.127 REF.			0.0	005 REF	
A1	0.00	0.02	0.05	0.000	0.001	0.002
b	0.20	0.25	0.30	0.008	0.010	0.012
D	1.45	1.50	1.55	0.057	0.059	0.061
D2	1.15	1.20	1.25	0.045	0.047	0.049
Ε	1.45	1.50	1.55	0.057	0.059	0.061
E2	0.65	0.70	0.75	0.026	0.028	0.030
e	0.500 BSC			0.	020 BS	С
L	0.125	0.175	0.225	0.005	0.007	0.009
К	0.230	-	-	0.009	-	-

Figure 15 Package Outline Drawing



*Dimensions (mm)

Figure 16 Recommended Land Pattern

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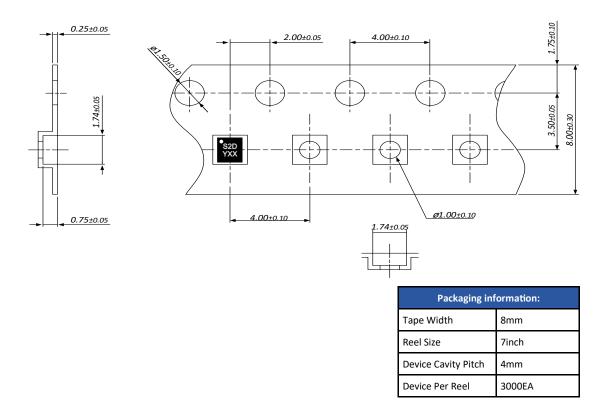
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BSW7321

Tape & Reel





Package Marking



	Marking information:						
	Marking Code 1		Marking Code 2				
S	RF Switch	2 The number of switch throw					
2	The number of switch throw	D	Sequential Number				
D	Sequential Number	хх	Wafer Lot Number				
Y	Work Year						
хх	Wafer Lot Number						

Figure 18 Package Marking

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Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)

MSL / ESD Rating

ESD information:			
Rating Class 2 (2000V)			
Test	Human Body Model (HBM)		
Standard	JS-001-2017		

MSL information:				
Rating	Level 1 at +260°C convection reflow			
Standard	JEDEC Standard J-STD-020			



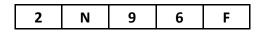
Proper ESD procedures should be followed when handling the device.

RoHS Compliance

This part is compliant with Restrictions on the use of certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU.

This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

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